

# TLV62568EVM-789 and TLV62569EVM-789 Evaluation Modules

This user's guide describes the characteristics, operation, and use of TI's TLV62568 and TLV62569 evaluation modules (EVM). These EVMs are designed to help the user easily evaluate and test the operation and functionality of the TLV62568 (1-A) and TLV62569 (2-A) buck converters. The EVMs convert a 2.5-V to 5.5-V input voltage to a regulated 1.8-V output voltage that delivers up to 2 A. This user's guide includes setup instructions for the hardware, a printed-circuit board (PCB) layout, a schematic diagram, a bill of materials (BOM), and test results of the EVM. Throughout this document, TLV6256xEVM-789 is used as an abbreviation representing the TLV62568EVM-789 (001) and TLV62569EVM-789 (002) EVMs.

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Introduction www.ti.com

### 1 Introduction

The TLV62568DBV and TLV62569DBV are synchronous step-down converters in 2.9-mm  $\times$  2.8-mm, 5-pin SOT-23 package. The TLV62568EVM-789 (PWR789-001) uses the TLV62568DBV integrated circuit (IC). The TLV62569EVM-789 (PWR789-002) uses the TLV62569DBV IC.

# 1.1 Performance Specification

Table 1 provides a summary of the TLV6256xEVM-789 performance specifications.

**Table 1. Performance Specification Summary** 

	Specification	Test Conditions	MIN	TYP	MAX	Unit
Input voltage			2.5		5.5	V
Output voltage setpoi	nt			1.8		V
Output current	TLV62568EVM-789		0		1	Α
	TLV62569EVM-789		0		2	Α

# 1.2 Thermal Data

Table 2 and Table 3 show the TLV62568EVM-789 and TLV62569EVM-789 thermal data after considering the printed-circuit board (PCB) design of real applications compared to the JEDEC values listed in the data sheet.

Table 2. TLV62568EVM-789 Thermal Data

	Thermal Metric <sup>(1)</sup>	TLV62568EVM-789	TLV62568 Data Sheet (JEDEC)	Unit
$R_{\theta JA}$	Junction-to-ambient thermal resistance	154.2	191.6	
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	N/A	141.4	
$R_{\theta JB}$	Junction-to-board thermal resistance	N/A	44.5	°C/W
ΨЈТ	Junction-to-top characterization parameter	23.2	34.5	
ΨЈВ	Junction-to-board characterization parameter	83.3	43.9	

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

Table 3. TLV62569EVM-789 Thermal Data

	Thermal Metric <sup>(1)</sup>	TLV62569EVM-789	TLV62569 Data Sheet (JEDEC)	Unit
$R_{\theta JA}$	Junction-to-ambient thermal resistance	151	188.2	
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	N/A	137.5	
$R_{\theta JB}$	Junction-to-board thermal resistance	N/A	41.2	°C/W
$\psi_{JT}$	Junction-to-top characterization parameter	20.3	31.4	
$\psi_{JB}$	Junction-to-board characterization parameter	80.1	40.6	

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.



www.ti.com Introduction

### 1.3 Modifications

The printed-circuit board (PCB) for this EVM is designed to accommodate the adjustable voltage version of this IC. On the EVM, additional input and output capacitors can be added. Finally, a feedforward capacitor can be added.

### 1.3.1 Input and Output Capacitors

C4 is provided for an additional input capacitor. This capacitor is not required for proper operation but can be used to reduce the input voltage ripple.

C6, C7, and C8 are provided for additional output capacitors. These capacitors are not required for proper operation but can be used to reduce the output voltage ripple and to improve the load transient response. The output capacitance must remain within the recommended range in the TPS62568 (SLVSD89) and TPS62569 (SLVSDG1) data sheet for proper operation.

## 1.3.2 Feedforward Capacitor

C5 is provided for the installation of an optional feedforward capacitor. This capacitor is not required for proper operation but can be used to improve the load transient performance.

# 2 Setup

This section describes how to properly use the TLV6256xEVM-789.

# 2.1 Connector Descriptions

J1, Pin 1 and 2 – VIN	Positive input voltage connection from the input supply for the EVM.
J1, Pin 3 and 4 – S+/S–	Input voltage sense connections. Measure the input voltage at this point.
J1, Pin 5 and 6 – GND	Input return connection from the input supply for the EVM.
J2, Pin 1 and 2 – VOUT	Positive output voltage connection.
J2, Pin 3 and 4 – S+/S-	Output voltage sense connections. Measure the output voltage at this point.
J2, Pin 5 and 6 – GND	Output return connection.
JP1 – EN	EN pin jumper. Place the supplied jumper across ON and EN to turn on the IC. Place the jumper across OFF and EN to turn off the IC.

# 2.2 Hardware Setup

To operate the EVM, set jumpers JP1 to the desired positions per Section 2.1. Connect the input supply to J1, and connect the load to J2.

### 3 TLV6256xEVM-789 Test Results

The TLV6256xEVM-789 was used to take the data in the TLV62568 and TLV62569 data sheet. See the device data sheet for the performance of this EVM.



Board Layout www.ti.com

# 4 Board Layout

This section provides the TLV6256xEVM-789 board layout and illustrations. The Gerbers are available on the EVM product pages: TLV62568EVM-789 and TLV62569EVM-789.

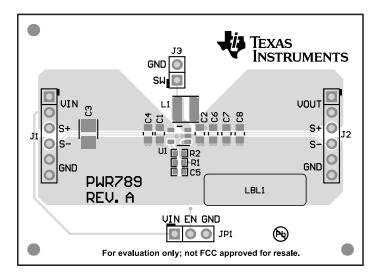


Figure 1. Top Assembly

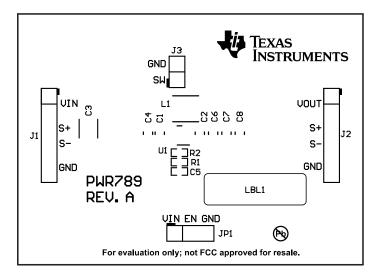


Figure 2. Top Overlay



www.ti.com Board Layout

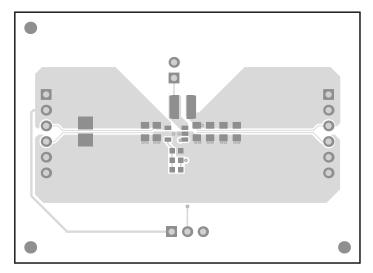


Figure 3. Top Layer

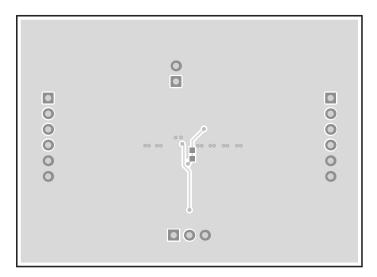


Figure 4. Bottom Layer



# 5 Schematic and Bill of Materials

This section provides the TLV6256xEVM-789 schematic and bill of materials.

# 5.1 Schematic

Figure 5 illustrates the EVM schematic.

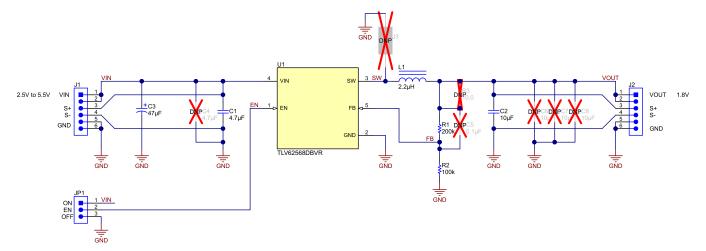


Figure 5. TLV6256xEVM-789 Schematic

# 5.2 Bill of Materials

Table 4 lists the BOM for this EVM.

Table 4. TLV6256xEVM-789 Bill of Materials

Qty							
TLV62568EVM -789	TLV62569EVM -789	Ref Des Value		lue Description	Size	Part Number	Manufacturer
1	1	C1	4.7uF	Capacitor, Ceramic, 10V, X7R, +/-10%	0805	GRM21BR71A475KA73L	Murata
1	1	C2	10uF	Capacitor, Ceramic, 10V, X7R, +/-10%	0805	GRM21BR71A106KE51L	Murata
1	1	C3	47uF	Capacitor, Tantalum, 6.3V, +/- 20%	3528-21	T520B476M006ATE025	Kemet
1	0	L1	2.2uH	Inductor, Shielded, 2.8 A, 0.045 ohm	4x4mm	SDER041H-2R2MS	Cyntec
0	1	L1	2.2uH	Inductor, Shielded, 5.5 A, 0.04 ohm	4x4mm	XAL4020-222MEB	Coilcraft
1	1	R1	200k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	1	R2	100k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	0	U1	TLV62568	IC, 5.5V 1A Step-Down Converter	2.9x2.8mm	TLV62568DBV	TI
0	1	U1	TLV62569	IC, 5.5V 2A Step-Down Converter	2.9x2.8mm	TLV62569DBV	TI

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NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

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- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

### **Concerning EVMs Including Radio Transmitters:**

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

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- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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